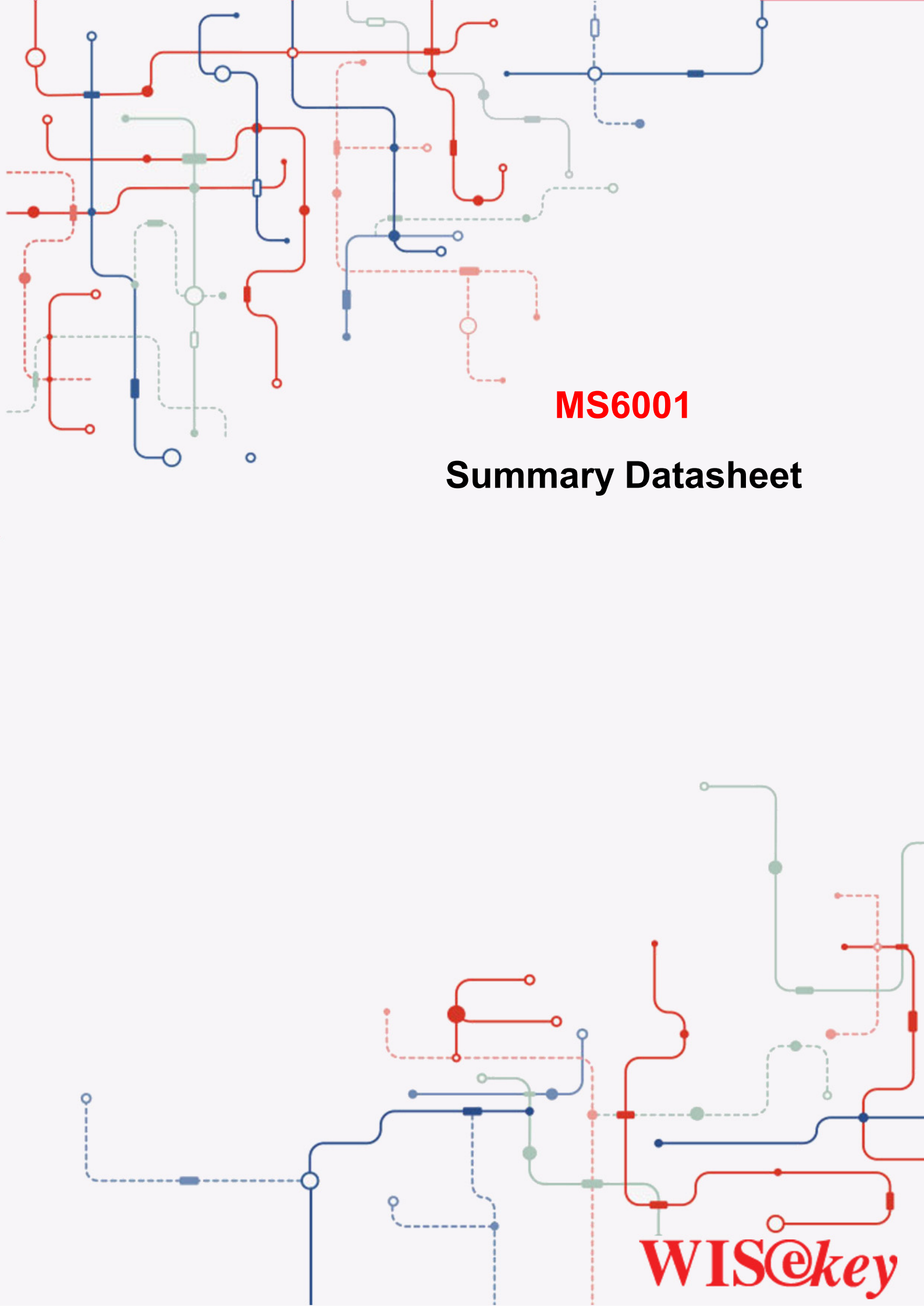
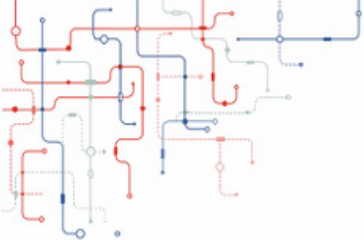


A decorative background pattern resembling a circuit board, with various colored lines (red, blue, green, grey) and components (circles, squares, rectangles) connected in a complex, non-linear fashion. The pattern is more dense in the top-left and bottom-right corners.

MS6001

Summary Datasheet

WIS@key



Features

General

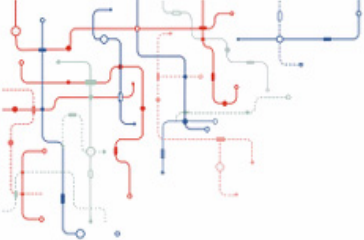
- Based on the ARM® SC300™ SecureCore™ 32-bit RISC Processor featuring:
 - Harvard architecture
 - Thumb2® High-code-density Instruction Set
 - 3-stage pipeline architecture
 - 8-bit,16-bit,32-bit data access
 - Nested Vector Interrupt Controller
 - Memory Protection Unit
- On-chip Programmable System Clock up to 50MHz
- Very Low Power Consumption
 - GSM & ETSI compliant
 - Low power Idle and Power down Modes
- Bond Pad Locations Confirming to ISO7816-2
- ESD Protection : $\pm 4000V$
- Operating range:
 - From 1.62V to 5.5V
 - From - 40°C to 105°C
- Compliant with GSM, 3GPP, EMVCo Specifications

Memory

- 1MBytes of FLASH Memory:
 - 128 or 256 bytes Page
 - Write Time : 50 μs / Word (32-bit)
 - Sector Erase : 2KBytes
 - Erase Time : 1 ms -> 7 ms
 - Flash write & erase low power modes (Idle and Deep)
 - 2KB of OTP
 - Typically 100,000 Write/Erase Cycles, 10 Years Data Retention at a Temperature of 25°C
 - 500,000 Write/Erase Cycles using Wear-levelling
- 64K bytes of ROM for Crypto Library, Wear-Leveling and Secure Bootloader code
- 24K bytes RAM Memory (20K bytes of ARM CPU Core RAM, 4K bytes of Ad-X™3 RAM, shared with the ARM CPU Core)

Peripherals

- Two I/O Ports
- Three GPIOs (shared with NFCIC Controller or HSSPI)
- One ISO 7816 Controller
 - Up to 625 Kbps at 5MHz
 - Compliant with T=0 and T=1 Protocols
- One NFCIC Controller:
 - ISO 14443 type A,B; ISO 18092;ISO 15693
 - External 13.56MHz
- SWP Slave interface: Single Wire Protocol controller for communications with NFC chip
- High Speed SPI Interface up to 20Mbits/s
- I²C Interface up to 1Mbits/s
- Three 16-bit Timers
- SysTick 24-bit timer, part of the SC300
- Interfaces and Class detectors
- Random Number Generator (RNG)
- Hardware DES/TDES DPA /DEMA Resistant
- Hardware AES
- CRC 16 & 32 Engine (Compliant with ISO/IEC 3309)
- 32-bit Cryptographic Accelerator (Ad-X3 for Public Key Operations)
 - RSA, DSA, ECC, ECDH
- Hardware accelerator compliant with HID™ access control solution
- High performance Hardware Java Card Accelerator
- Dedicated Power Supply for GPIOs (SPI), I2C and IO1 interfaces



Security

- Dedicated Hardware for Protection Against SPA/DPA/SEMA/DEMA Attacks
- Advanced Protection Against Physical Attack, Including Active Shield, Enhanced Protection Object, Stack Checker, Slope Detector, Parity Errors
- Environmental Protection Systems
- Voltage Monitor
- Frequency Monitor
- Temperature Monitor
- Light Protection
- Secure Memory Management/Access Protection
- Memory Protection Unit, part of the SC300

Development Tools

- Keil RVDS Development Suite
- IAR Embedded Workbench® EWARM
- Software Libraries and Application Notes

Certification Targeted

- CC EAL5+
- EMVCo
- FIPS 140-2

Description

The MS6001 architecture is based on the ARM® SecurCore® SC300 which offer high performance and very low power consumption. The core features a Thumb-2 instruction set, low interrupt latency, hardware divide, interruptible/continuable multiple load and store instructions, automatic state save and restore for interrupts, tightly integrated interrupt controller and multiple core buses capable of simultaneous accesses. Pipeline techniques are employed ensuring that all parts of the processing and memory systems can operate continuously.

The SC300 instruction set provides the exceptional performance expected of a modern 32-bit architecture, with the high code density of 8-bit and 16-bit microcontrollers. The processor closely integrates a configurable nested vectored interrupt controller (NVIC), to deliver industry leading interrupt performance. To offer efficient low-power modes, the NVIC features a deep sleep function that enables the entire device to be rapidly powered down.

The MS6001 features a ROM memory dedicated to the storage of low level drivers, bootloader, Wear Leveling and cryptographic code. A large flash memory mapped in both data and code space provide a flexible way to store user data and program code.

The Ad-X3 hardware cryptographic accelerator featured in the MS6001 is dedicated to perform fast encryption or authentication functions.

Thanks to the in-built MPU of the SC300, the MS6001 can enforce privilege rules, separate processes, enforces access rules over the whole 4GB addressing space.

Additional security features include power and frequency protection logic, logical scrambling on program data and addresses, power analysis countermeasures and memory accesses controller by privileged modes.

Thanks to its dedicated set of peripherals, the MS6001 is an ideal product for application such as a Secure Element, compliant to ETSI standards. Moreover, through its specific choice of communication interfaces, the MS6001 is able to provide a tailored solution to applications in embedded systems.

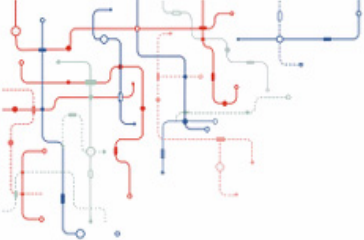
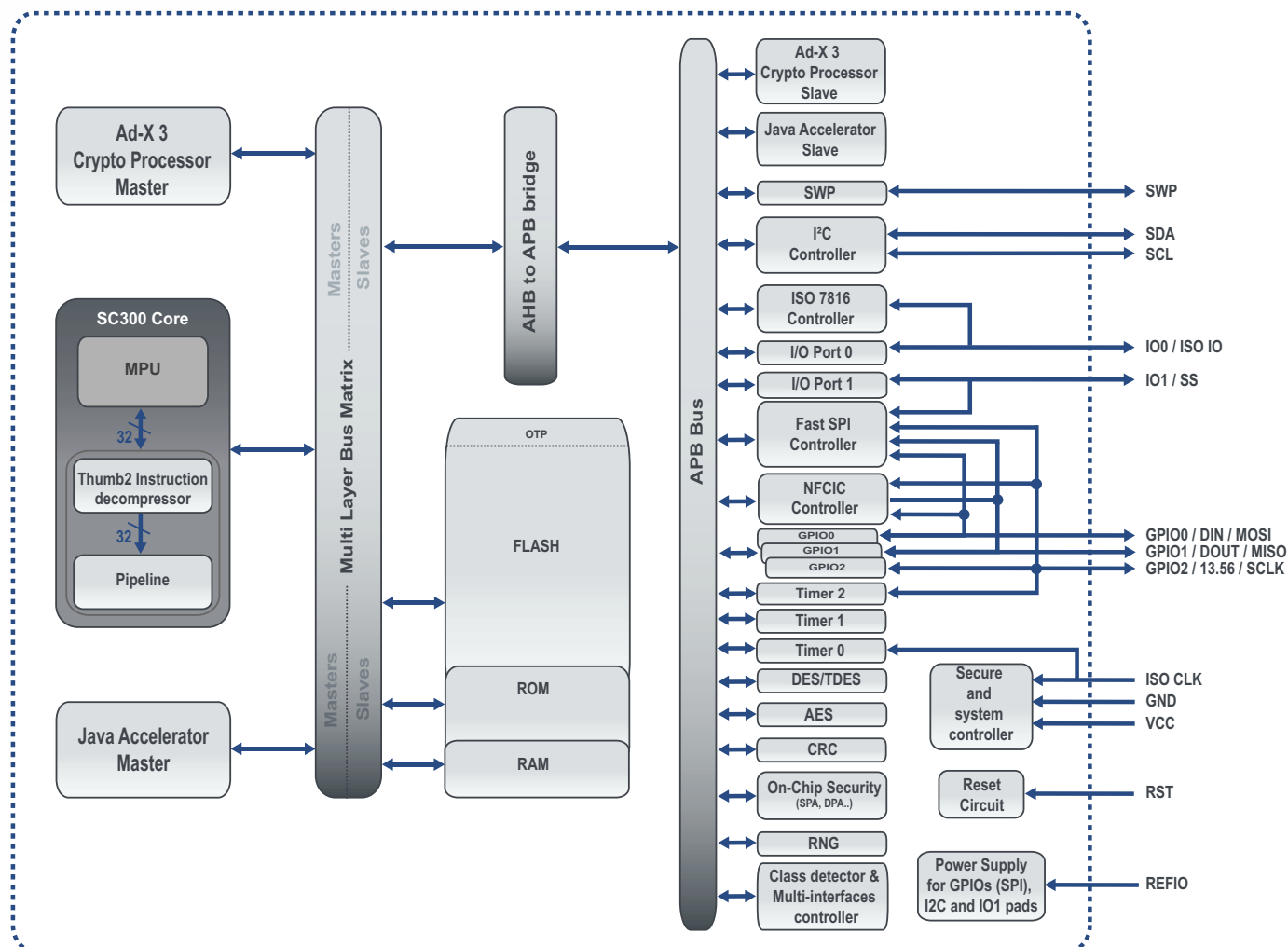


Figure 1 MS6001 ARM CPU Core Architecture





AC/DC Characteristics

Maximum Ratings

Parameter	Symbol	Min.	Max.	Unit
Supply Voltage	V_{CC}	-0.3	7	V
Operating Temperature	T_A	-40	+105	°C

AC/DC Characteristics (1.62V - 5.50V range; T= -40°C to +105°C)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
V_{CC}	Supply Voltage		1.62		5.5	V
F_{VFO}	Processor Clock Input Frequency	with $V_{CC}=4.5V$ config 20MHz config 50MHz	18 46	20 50	24 61	MHz
$F_{peripheral}$	Peripheral Clock Frequency	with $V_{CC}=4.5V$	18	22	24	MHz
V_{MAX}	Voltage Monitor: High Level Detection		6.1	6.3	6.4	V
V_{MIN}	Voltage Monitor: Low Level Detection		1.1	1.2	1.6	V
T_{MAX}	Temperature monitor High Level Detection			110		°C
T_{MIN}	Temperature monitor Low Level Detection			-40		°C
V_{POR}	Power-on Reset Voltage		1	1	1.45	V
t_{POR}	Power-on Reset Period	$V_{CC}=5V$ V_{CC} rise time=10 μ s LowPowerStartup=0 LowPowerStartup=1		112 226		μ s
t_{TOUT}	Reset Delay Time-out Period	warm reset ISO400 fuse = 0		523		t_{CYC}
		warm reset ISO400 fuse = 1	the longest of 523 t_{CYC} or 7 t_{CYC} + 403 t_{isoclk}			
		POR (cold reset) LowPowerStartup=0 LowPowerStartup=1		980 2549		t_{CYC}
t_{FLASHW}	FLASH Write Time	per word	50	55	60	ms
t_{FLASHE}	FLASH Erase Time	erase+verify	2	2+0.5	10	ms
t_{CYC}	CPU Cycle Time	LowPowerStartup=0 LowPowerStartup=1		4/ F_{VFO} 1/ F_{VFO}		ns
RST I_{IL}	Leakage Current RST	$V_{IN}=0V$		0		μ A
RST I_{IH}	Leakage Current RST	$V_{IN}=V_{CC}$		0		μ A
RST V_{IH}	Input High Voltage, RST signal		0.7xVcc	NA	Vcc+0.3	V
RST V_{IL}	Input Low Voltage, RST signal		-0.3	NA	0.2 x Vcc	V
CLK I_{IL}	Leakage Current CLK	$V_{IN} = 0$		0		μ A
CLK I_{IH}	Leakage Current CLK	$V_{IN} = V_{CC}$		0		μ A
CLK V_{IH}	Input High Voltage, CLK signal		0.7xVcc	NA	Vcc+0.3	V



Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
CLK V_{IL}	Input Low Voltage, CLK signal		-0.3	NA	$0.2 \times V_{CC}$	V
I/O I_{IL}	Leakage Current I/O	$V_{IN}=0$		0		μA
I/O I_{IH}	Leakage Current I/O	$V_{IN}=V_{CC}$		0		μA
I/O V_{IH}	Input High Voltage, I/O signal		$0.7 \times V_{CC}$	NA	$V_{CC}+0.3$	V
I/O V_{IL}	Input Low Voltage, I/O signal		-0.3	NA	$0.2 \times V_{CC}$	V
I/O V_{OH}	Output High Voltage, I/O signal	$I_{OH}=20\mu A$ $R_{PULLUP}=20K$	0.97			$\times V_{CC}$
I/O V_{OL}	Output Low Voltage, I/O signal	$I_{OL}<1mA$, ClassA	0.004	0.005	0.007	$\times V_{CC}$
I/O V_{OL}	Output Low Voltage, I/O signal	$I_{OL}<0.5mA$, ClassB	0.005	0.006	0.008	$\times V_{CC}$
I/O V_{OL}	Output Low Voltage, I/O signal	$I_{OL}<0.5mA$, ClassC	0.013	0.015	0.020	$\times V_{CC}$
T_r	I/O Output Rise Time	$C_{out} = 30 pF$, $R_{PULLUP} = 220K$	9.2	12.1	18.3	ns
T_f	I/O Output Fall Time	$C_{out} = 30 pF$	10.1	13.0	20.1	ns
$R_{I/O PULLUP}$	RST Pin Pullup IO0 Pin Pullup SCK Pin Pullup SWP Pin Pullup			220 220 220 900		$k\Omega$
$R_{I/O PULLDOWN}$	RST Pin Pulldown IO0 Pin Pulldown SCK Pin Pulldown SWP pad Pulldown			1000 1000 1000 900		$k\Omega$

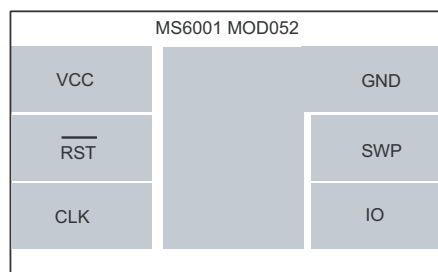
Note: 1. In deep sleep Mode, the external clock can be stopped. The Frequency and temperature Monitors are switched off.



Pin and Packages Configurations

Module Configuration.

GND	Ground (reference voltage)
VCC	Power supply input
ISO I/O	Input or Output for serial data (ISO 7816)
ISO CLK	ISO CLK ISO 7816 input clock
ISO $\overline{\text{RST}}$	ISO Reset signal input
SWP	SWP dedicated pin

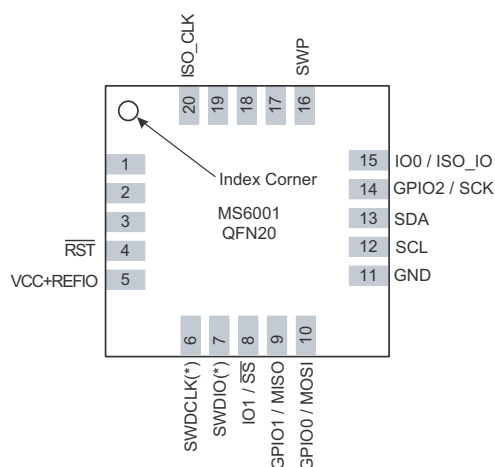


Embedded Configuration (QFN20).

GND	Ground (reference voltage)
VCC	Power supply input
I/O1 / $\overline{\text{SS}}$	IO1 or SPI Slave Select
GPIO0 / MOSI	GPIO0 or SPI MOSI
GPIO1 / MISO	GPIO1 or SPI MISO
GPIO2 / SCK	GPIO2 or SPI clock
SDA	I2C SDA
SCL	I2C SCL

Only on QFN20:

SWP	Single Wire Protocol
I/O0 / ISO_IO	IO0 or ISO IO
ISO_CLK	ISO CLK ISO 7816 input clock
SWDCLK	Single Wire Debug Clock
SWDIO	Single Wire Debug IO
$\overline{\text{RST}}$	Reset



(*)only for engineering sample

Configuration	Interfaces Available	Package
QFN20	SWP + I2C + { (SPI + ISO) or (SPI + 1GPIO) or (ISO+ 4GPIO) or (5GPIO) }	QFN20 (4*4)

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